# **Complementary Silicon Plastic Power Transistors**

Designed for use in general purpose amplifier and switching applications. Compact TO-220 AB package.

#### **Features**

Pb-Free Packages are Available\*

#### MAXIMUM RATINGS

Rating	Symbol	29 30	29A 30A	29B 30B	29C 30C	Unit
Collector – Emitter Voltage	V <sub>CEO</sub>	40	60	80	100	Vdc
Collector - Base Voltage	V <sub>CB</sub>	40	60	80	100	Vdc
Emitter - Base Voltage	V <sub>EB</sub>	5.0			Vdc	
Collector Current - Continuous - Peak	I <sub>C</sub>	1.0 3.0			Adc	
Base Current	ΙΒ	0.4			Adc	
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	30 0.24			W W/°C	
Total Power Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	2.0 0.016			W W/°C	
Unclamped Inductive Load Energy (Note 1)	Е	32			mJ	
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150			°C	

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W
Thermal Resistance, Junction-to-Case	R <sub>0JC</sub>	4.167	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

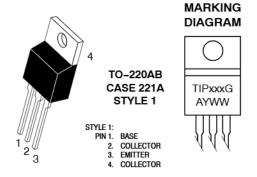
1. This rating based on testing with  $L_C$  = 20 mH,  $R_{BE}$  = 100  $\Omega$ ,  $V_{CC}$  = 10 V,  $I_C$  = 1.8 A, P.R.F = 10 Hz



### ON Semiconductor®

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# 1 AMPERE **POWER TRANSISTORS COMPLEMENTARY SILICON** 40, 60, 80, 100 VOLTS, 80 WATTS



TIPxxx = Device Code:

29. 29A. 29B. 29C 30, 30A, 30B, 30C

= Assembly Location

Year WW = Work Week Pb-Free Package

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

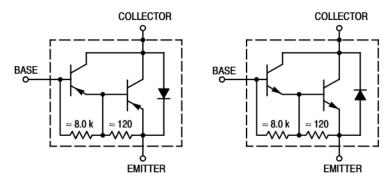


Figure 1. Darlington Circuit Schematic

## ORDERING INFORMATION

Device	Package	Shipping	
TIP29	TO-220	50 Units / Rail	
TIP29G	TO-220 (Pb-Free)	50 Units / Rail	
TIP29A	TO-220	50 Units / Rail	
TIP29AG	TO-220 (Pb-Free)	50 Units / Rail	
TIP29B	TO-220	50 Units / Rail	
TIP29BG	TO-220 (Pb-Free)	50 Units / Rail	
TIP29C	TO-220	50 Units / Rail	
TIP29CG	TO-220 (Pb-Free)	50 Units / Rail	
TIP30	TO-220	50 Units / Rail	
TIP30G	TO-220 (Pb-Free)	50 Units / Rail	
TIP30A	TO-220	50 Units / Rail	
TIP30AG	TO-220 (Pb-Free)	50 Units / Rail	
TIP30B	TO-220	50 Units / Rail	
TIP30BG	TO-220 (Pb-Free)	50 Units / Rail	
TIP30C	TO-220	50 Units / Rail	
TIP30CG	TO-220 (Pb-Free)	50 Units / Rail	

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•	•	
Collector-Emitter Sustaining Voltage ( $I_C =$	30 mAdc, I <sub>B</sub> = 0) (Note 2) TIP29, TIP30 TIP29A, TIP30A TIP29B, TIP30B TIP29C, TIP30C	VCEO(sus)	40 60 80 100	- - - -	Vdc
Collector Cutoff Current $(V_{CE} = 30 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 60 \text{ Vdc}, I_B = 0)$	TIP29, TIP29A, TIP30, TIP30A TIP29B, TIP29C, TIP30B, TIP30C	ICEO	- -	0.3 0.3	mAdc
Collector Cutoff Current $ \begin{aligned} &(\text{V}_{\text{CE}} = 40 \text{ Vdc}, \text{V}_{\text{EB}} = 0) \\ &(\text{V}_{\text{CE}} = 60 \text{ Vdc}, \text{V}_{\text{EB}} = 0) \\ &(\text{V}_{\text{CE}} = 80 \text{ Vdc}, \text{V}_{\text{EB}} = 0) \\ &(\text{V}_{\text{CE}} = 100 \text{ Vdc}, \text{V}_{\text{EB}} = 0) \end{aligned} $	TIP29, TIP30 TIP29A, TIP30A TIP29B, TIP30B TIP29C, TIP30C	I <sub>CES</sub>	- - - -	200 200 200 200	μAdc
Emitter Cutoff Current ( $V_{BE} = 5.0 \text{ Vdc}$ , $I_{C} =$	I <sub>EBO</sub>	-	1.0	mAdd	
ON CHARACTERISTICS (Note 2)	•		•	•	
DC Current Gain ( $I_C = 0.2$ Adc, $V_{CE} = 4.0$ Vdc) ( $I_C = 1.0$ Adc, $V_{CE} = 4.0$ Vdc)		h <sub>FE</sub>	40 15	- 75	-
Collector-Emitter Saturation Voltage (I <sub>C</sub> = 1.0 Adc, I <sub>B</sub> = 125 mAdc)		V <sub>CE(sat)</sub>	-	0.7	Vdc
Base-Emitter On Voltage (I <sub>C</sub> = 1.0 Adc, V <sub>CE</sub> = 4.0 Vdc)		V <sub>BE(on)</sub>	-	1.3	Vdc
DYNAMIC CHARACTERISTICS	-		•	'	
Current-Gain - Bandwidth Product (Note 3) $(I_C = 200 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f_{test} = 1.0 \text{ MHz})$		f <sub>T</sub>	3.0	-	MHz
Small-Signal Current Gain (I <sub>C</sub> = 0.2 Adc, V <sub>CE</sub> = 10 Vdc, f = 1.0 kHz)		h <sub>fe</sub>	20	-	-

<sup>2.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0% 3.  $f_T = |h_{fe}| \bullet f_{test}$ 

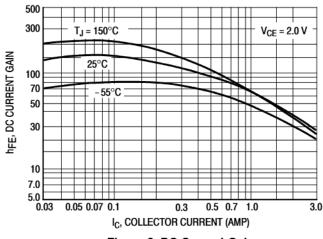


Figure 2. DC Current Gain

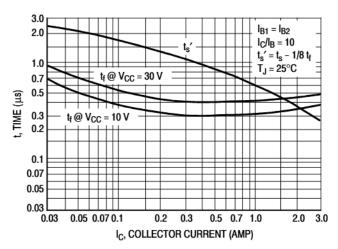


Figure 3. Turn-Off Time

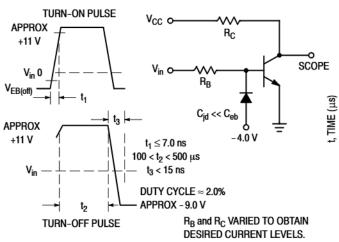


Figure 4. Switching Time Equivalent Circuit

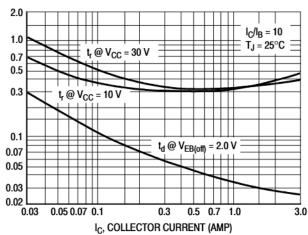


Figure 5. Turn-On Time

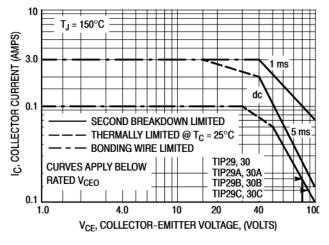


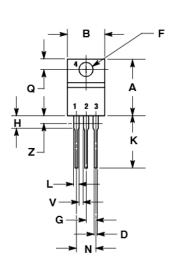
Figure 6. Active Region Safe Operating Area

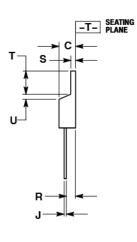
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 6 is based on  $T_{J(pk)} = 150^{\circ}C$ ;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \leq 150^{\circ}C$ . At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

### PACKAGE DIMENSIONS

TO-220 CASE 221A-09 ISSUE AG





#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.036	0.64	0.91	
F	0.142	0.161	3.61	4.09	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.161	2.80	4.10	
J	0.014	0.025	0.36	0.64	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
T	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
٧	0.045		1.15		
Z		0.080		2.04	

STYLE 1:

PIN 1. BASE

- COLLECTOR 2.
- EMITTER
- COLLECTOR

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